

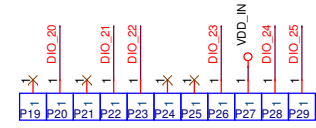
U1B

DIO_0	5	DIO_0	26	DIO_16
DIO_1	6	DIO_1	27	DIO_17
DIO_2	7	DIO_2	28	DIO_18
DIO_3	8	DIO_3	29	DIO_19
DIO_4	9	DIO_4	30	DIO_20
DIO_5	10	DIO_5	31	DIO_21
DIO_6	11	DIO_6	32	DIO_22
DIO_7	12	DIO_7	33	DIO_23
DIO_8	13	DIO_8	34	DIO_24
DIO_9	14	DIO_9	35	DIO_25
DIO_10	15	DIO_10	36	DIO_26
DIO_11	16	DIO_11	37	DIO_27
DIO_12	17	DIO_12	38	DIO_28
DIO_13	18	DIO_13	39	DIO_29
DIO_14	19	DIO_14	40	DIO_30
DIO_15	20	DIO_15	41	DIO_31
DIO_16	21	DIO_16	42	DIO_32
DIO_17		DIO_17	43	DIO_33
DIO_18		DIO_18		
DIO_19		DIO_19		
DIO_20		DIO_20		
DIO_21		DIO_21		
DIO_22		DIO_22		
DIO_23		DIO_23		
DIO_24		DIO_24		
DIO_25		DIO_25		
DIO_26		DIO_26		
DIO_27		DIO_27		
DIO_28		DIO_28		
DIO_29		DIO_29		
DIO_30		DIO_30		
DIO_31		DIO_31		
DIO_32		DIO_32		
DIO_33		DIO_33		

CC2650F128RGZ

P1	1	
P2	1	DIO_7
P3	1	DIO_8
P4	1	DIO_9
P5	1	DIO_10
P6	1	DIO_11
P7	1	DIO_12
P8	1	DIO_13
P9	1	DIO_14
P10	1	nRESET
P11	1	DIO_15
P12	1	DIO_16
P13	1	DIO_17
P14	1	DIO_18
P15	1	DIO_19
P16	1	DIO_20
P17	1	DIO_21
P18	1	DIO_22

P47	1	
P46	1	
P45	1	DIO_30
P44	1	DIO_0
P43	1	DIO_1
P42	1	DIO_2
P41	1	DIO_3
P40	1	DIO_4
P39	1	DIO_5
P38	1	DIO_6
P37	1	DIO_7
P36	1	DIO_8
P35	1	DIO_9
P34	1	DIO_10
P33	1	DIO_11
P32	1	DIO_12
P31	1	DIO_13
P30	1	DIO_14



Title: TIDC-BLUETOOTH-SMART-KEYBOARD-MODULE		
Drawn: NVS	Checked: NN	
Size: A3	Rev: 2.0.0	Sheet: 1 of 1
Date: Sunday, August 30, 2015		

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